IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appn. Number: 08/580,493 Appn. Filed: 1995 Dec 29 Philippe BERNA

Applicant:

Appn. Title: PROCESS FOR MAKING A VERSATILE CLAMPING DEVICE DESIGNED TO

HOLD OBJECTS WITHOUT DAMAGING THEM, SUCH A DEVICE AND ITS USE

Examiner/GAU: Tom Hughes/3726

Molières-sur-Cèze, France, 1998, December 11, Fri

REQUEST FOR FILE-WRAPPER-CONTINUING APPLICATION

RECEIVED

Assistant Commissioner for Patents Washington, District of Columbia 20231 DEC 2 2 1998

Group 3700

Sir:

Pursuant to Rule 62, please file a file-wrapper-continuing application of the above complete pending application. This Rule 62 continuing application is being actually express mailed during the pendency of the above application. It should be a Continuation of the above application. Please use the specification (including the claims and abstract) of the above application and also use the Declaration therefrom. There are no more than 3 independent claims and 20 total claims in this specification. Please use the drawings of the above application too.

A verified statement to establish small entity status was enclosed for the above application and such status is still proper and desired.

Thus the filing fee for the Rule 62 Application will be \$380; a check for this amount plus the amount of the extension fee is enclosed.

Very Respectfully

Philips BERNA

Philippe Berna, Applicant Pro Se

Mailing address: Mas Liotard - Les Brousses, F30410 Molières-sur-Cèze,

France (Phone: (33) 490 85 90 81, fax: (33) 490 85 90 81)

, Enc(s): Petition for Extension of Time, Filing and Extension fees, a SASE with a receipt form to be dated and stamped for mailing to my address in France.

CERTIFICATE OF EXPRESS MAILING

Express Mail Label # GN 756850705 FR; Date of Deposit 1998, December

I hereby certify that this paper and attached fee are being deposited with the United States Postal Service using "Express Mail Pos€ Office to Adressee" service under 37 CFR 1.10 on the date indicated above and is addressed to "Assistant Commissioner for Patents, Washington, D.C. 20231 &

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